

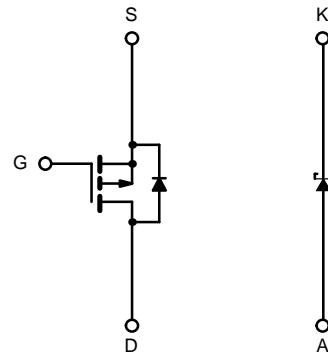
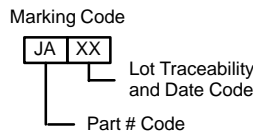
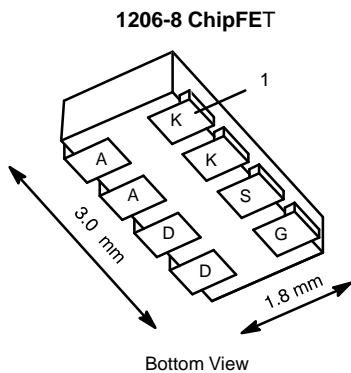


P-Channel 1.8-V (G-S) MOSFET With Schottky Diode

MOSFET PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
-20	0.110 @ $V_{GS} = -4.5$ V	-3.6
	0.160 @ $V_{GS} = -2.5$ V	-3.0
	0.240 @ $V_{GS} = -1.8$ V	-2.4

SCHOTTKY PRODUCT SUMMARY		
V_{KA} (V)	V_f (V) Diode Forward Voltage	I_F (A)
20	0.48 V @ 0.5 A	1.0

LITTLE FOOT Plus™



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)					
Parameter	Symbol	5 sec	Steady State	Unit	
Drain-Source Voltage (MOSFET and Schottky)	V_{DS}	-20		V	
Reverse Voltage (Schottky)	V_{KA}	20			
Gate-Source Voltage (MOSFET)	V_{GS}	± 8	± 8	A	
Continuous Drain Current ($T_J = 150^\circ\text{C}$) (MOSFET) ^a	$T_A = 25^\circ\text{C}$	I_D	-3.6		-2.7
	$T_A = 85^\circ\text{C}$		-2.6		-1.9
Pulsed Drain Current (MOSFET)	I_{DM}	-10			
Continuous Source Current (MOSFET Diode Conduction) ^a	I_S	-1.8	-0.9		
Average Forward Current (Schottky)	I_F	1.0			
Pulsed Forward Current (Schottky)	I_{FM}	7			
Maximum Power Dissipation (MOSFET) ^a	$T_A = 25^\circ\text{C}$	P_D	2.1	1.1	W
	$T_A = 85^\circ\text{C}$		1.1	0.6	
Maximum Power Dissipation (Schottky) ^a	$T_A = 25^\circ\text{C}$		1.3	0.96	
	$T_A = 85^\circ\text{C}$		0.68	0.59	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		$^\circ\text{C}$	

Notes
a. Surface Mounted on 1" x 1" FR4 Board.



THERMAL RESISTANCE RATINGS						
Parameter		Device	Symbol	Typical	Maximum	Unit
Junction-to-Ambient ^a	t ≤ 5 sec	MOSFET	R _{thJA}	50	60	°C/W
		Schottky		77	95	
	Steady State	MOSFET		90	110	
		Schottky		110	130	
Junction-to-Foot	Steady State	MOSFET	R _{thJF}	30	40	
		Schottky	33	40		

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

MOSFET SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA	-0.45			V
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±8 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -16 V, V _{GS} = 0 V			-1	μA
		V _{DS} = -16 V, V _{GS} = 0 V, T _J = 85°C			-5	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≤ -5 V, V _{GS} = -4.5 V	-10			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = -4.5 V, I _D = -2.7 A		0.095	0.110	Ω
		V _{GS} = -2.5 V, I _D = -2.2 A		0.137	0.160	
		V _{GS} = -1.8 V, I _D = -1 A		0.205	0.240	
Forward Transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -2.7 A		7		S
Diode Forward Voltage ^a	V _{SD}	I _S = -0.9 A, V _{GS} = 0 V		-0.8	-1.2	V
Dynamic^b						
Total Gate Charge	Q _g	V _{DS} = -10 V, V _{GS} = -4.5 V, I _D = -2.7 A		4.4	6.5	nC
Gate-Source Charge	Q _{gs}		1.4			
Gate-Drain Charge	Q _{gd}		0.65			
Turn-On Delay Time	t _{d(on)}	V _{DD} = -10 V, R _L = 10 Ω I _D ≅ -1 A, V _{GEN} = -4.5 V, R _G = 6 Ω		16	25	ns
Rise Time	t _r		30	45		
Turn-Off Delay Time	t _{d(off)}		30	45		
Fall Time	t _f		27	40		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = -0.9 A, di/dt = 100 A/μs		20	40	

Notes

a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.

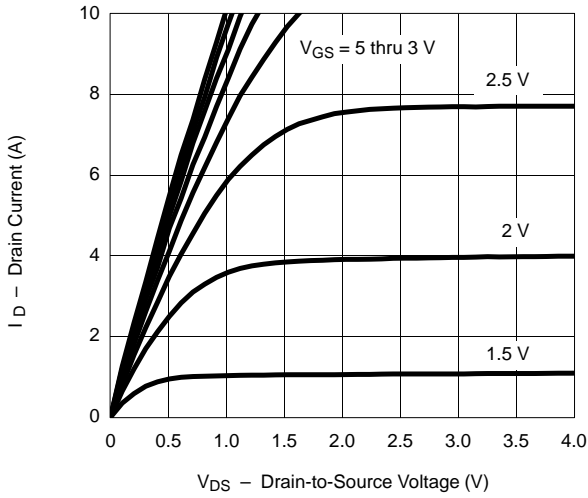
b. Guaranteed by design, not subject to production testing.

SCHOTTKY SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Forward Voltage Drop	V _F	I _F = 0.5 A		0.42	0.48	V
		I _F = 0.5 A, T _J = 125°C		0.33	0.4	
Maximum Reverse Leakage Current	I _{rm}	V _r = 20 V		0.002	0.100	mA
		V _r = 20 V, T _J = 85°C		0.10	1	
		V _r = 20 V, T _J = 125°C		1.5	10	
Junction Capacitance	C _T	V _r = 10 V		31		pF

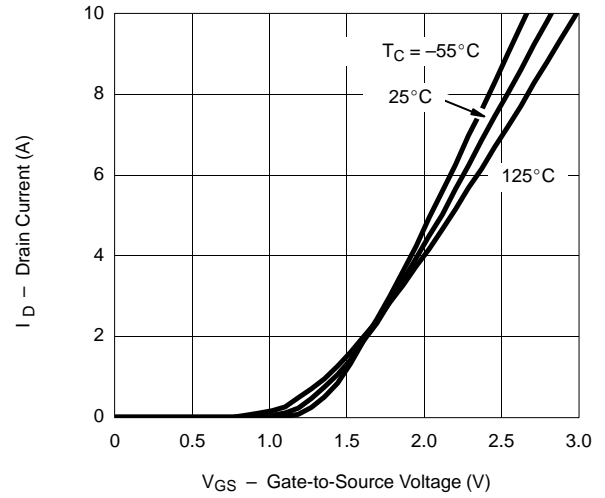


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) MOSFET

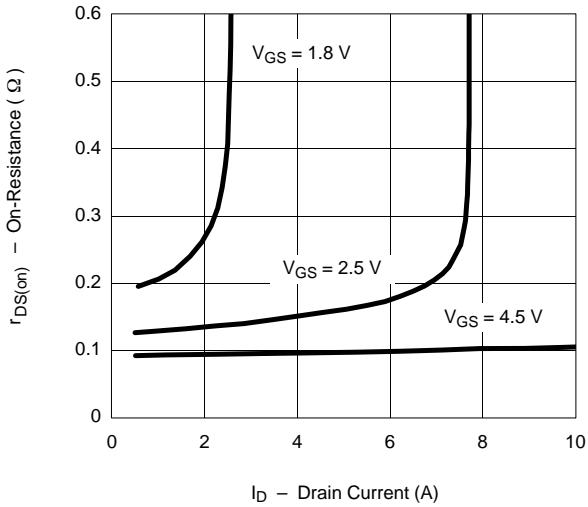
Output Characteristics



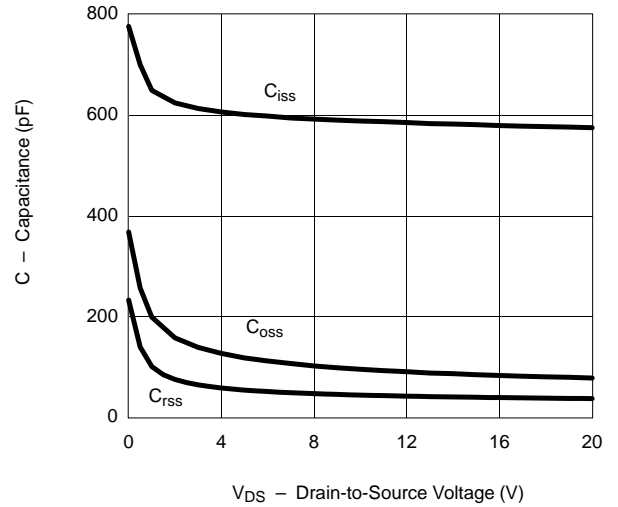
Transfer Characteristics



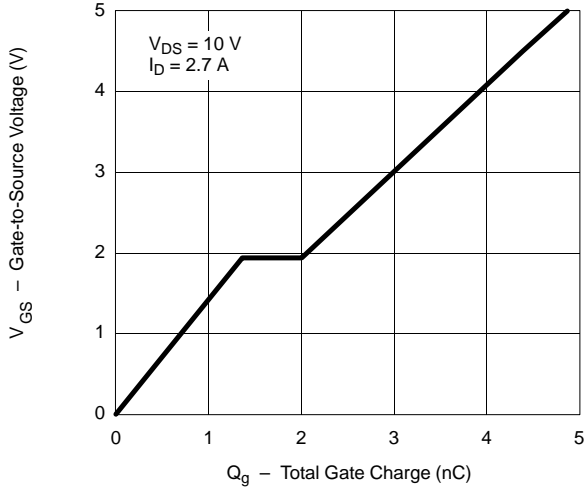
On-Resistance vs. Drain Current



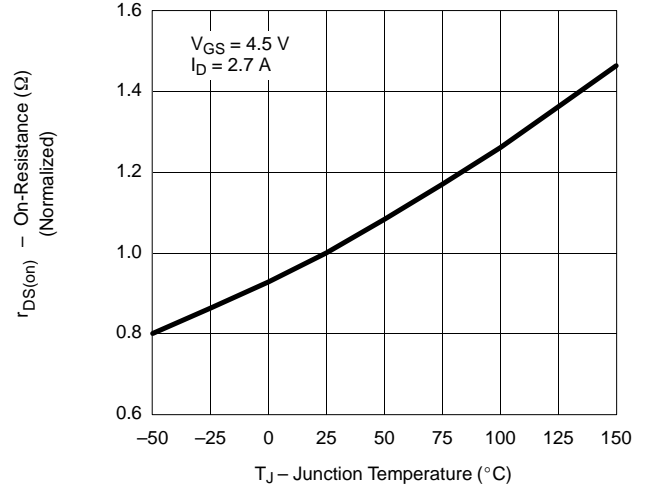
Capacitance



Gate Charge



On-Resistance vs. Junction Temperature

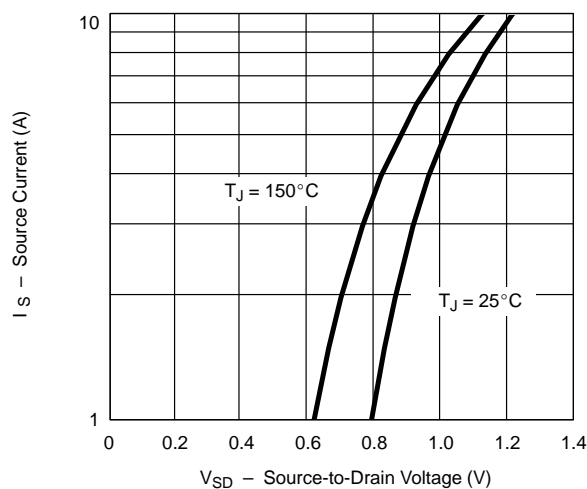




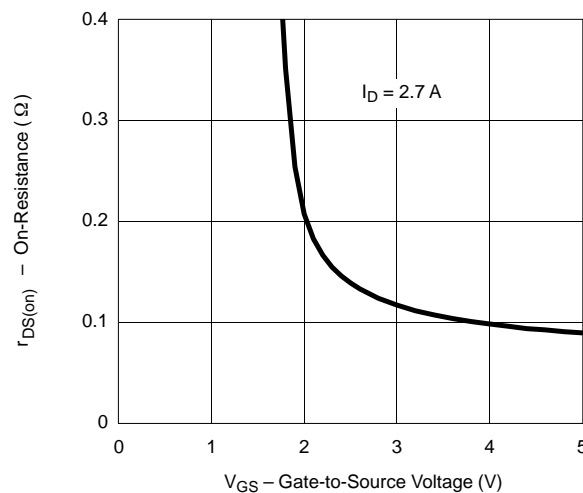
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

MOSFET

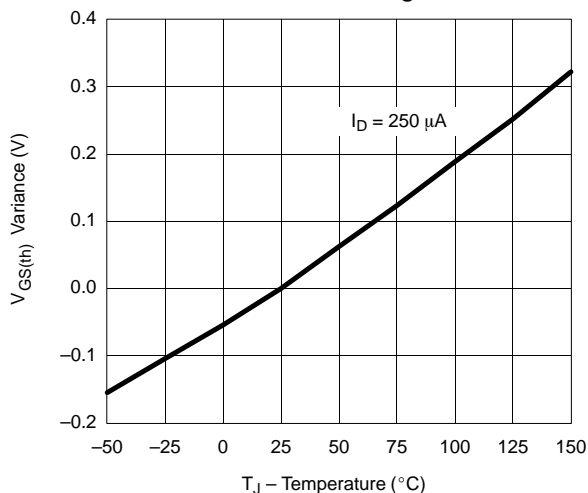
Source-Drain Diode Forward Voltage



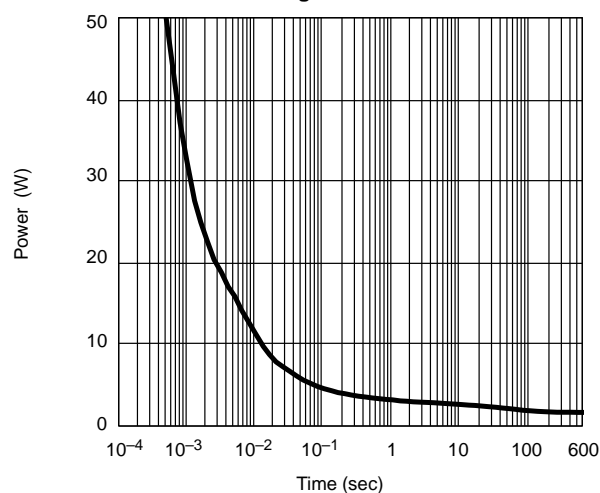
On-Resistance vs. Gate-to-Source Voltage



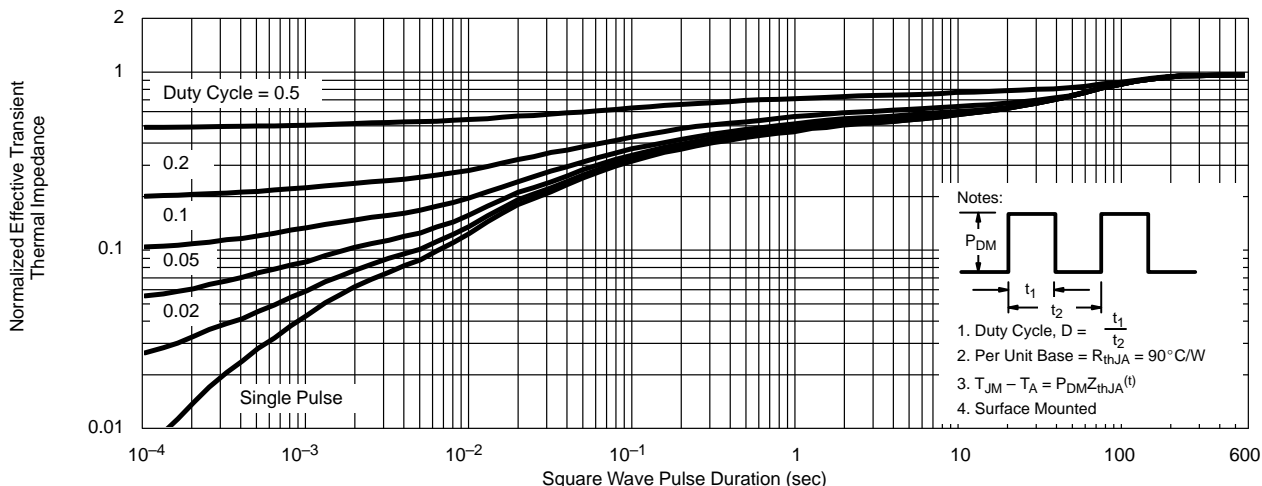
Threshold Voltage



Single Pulse Power



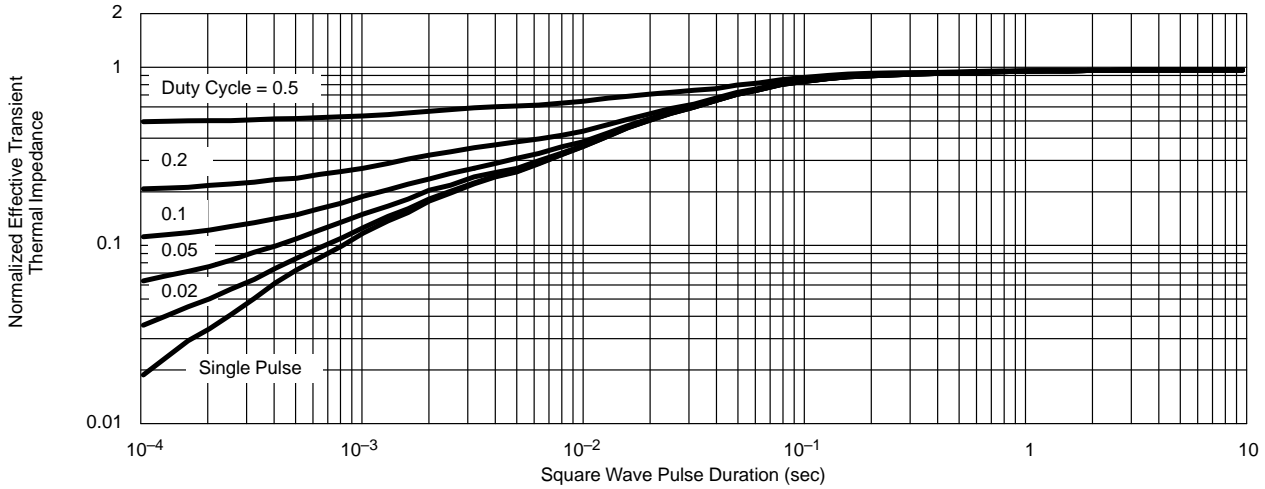
Normalized Thermal Transient Impedance, Junction-to-Ambient





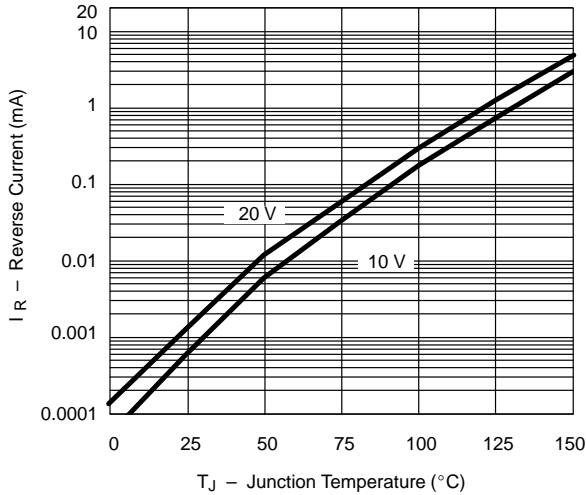
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) MOSFET

Normalized Thermal Transient Impedance, Junction-to-Foot

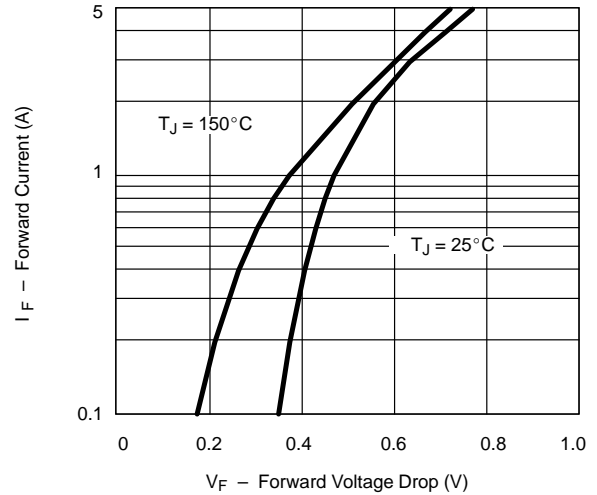


TYPICAL CHARACTERISTICS (25°C UNLESS NOTED) SCHOTTKY

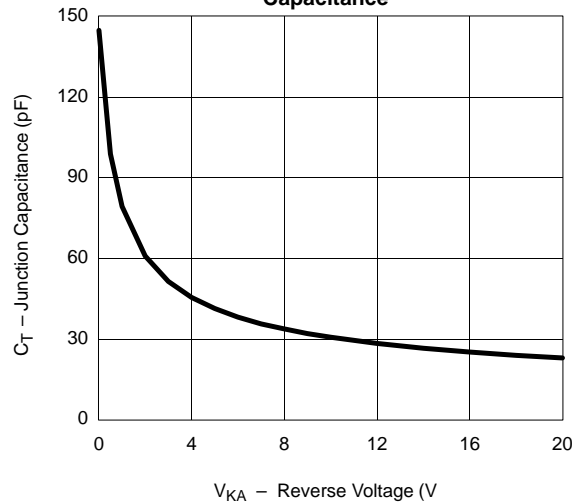
Reverse Current vs. Junction Temperature



Forward Voltage Drop



Capacitance





TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

SCHOTTKY

